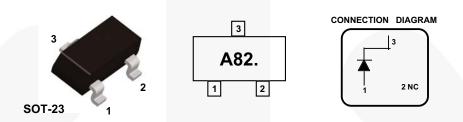


February 2015

BAS21 General-Purpose High Voltage Diode



Ordering Information

Part Number	ber Top Mark Package		Packing Method	
BAS21	A82.	SOT-23 3L	Tape and Reel	

Absolute Maximum Ratings(1), (2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter		Value	Unit
W _{IV}	Working Inverse Voltage		250	V
Io	Average Rectified Current		200	mA
l _F	DC Forward Current		600	mA
i _f	Recurrent Peak Forward Current		700	mA
İ _f (surge)	Peak Forward Surge Current	Pulse Width = 1.0 second	1.0	А
		Pulse Width = 1.0 microsecond	2.0	
T _{STG}	Storage Temperature Range		-55 to +150	°C
TJ	Operating Junction Temperature		150	°C

Notes

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

Thermal Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Max.	Unit
P _D	Total Device Dissipation	350	mW
	Derate Above 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	357	°C/W

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
B _V	Breakdown Voltage	Ι _R = 100 μΑ	250		V
I _R R	Reverse Voltage Leakage Current	V _R = 200 V		100	nA
		V _R = 200 V, T _A = 150°C		100	μΑ
V _F Fo	Forward Voltage	I _F = 100 mA		1.0	V
		I _F = 200 mA		1.25	V
Co	Diode Capacitance	V _R = 0, f = 1.0 MHz		5.0	pF
T _{RR}	Reverse Recovery Time	$I_F = I_R = 30 \text{ mA}, I_{RR} = 3.0 \text{ mA},$ $R_L = 100 \Omega$		50	nS

Typical Performance Characteristics

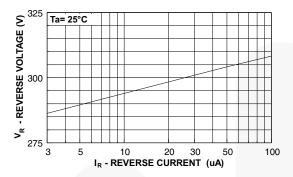


Figure 1. Reverse Voltage vs. Reverse Current BV - 1.0 to 100 μA

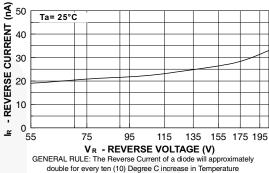


Figure 2. Reverse Current vs. Reverse Voltage I_R - 55 to 205 V

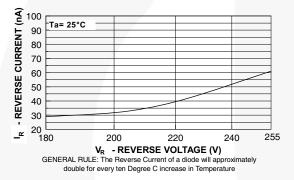


Figure 3. Reverse Current vs. Reverse Voltage I_R - 180 to 255 V

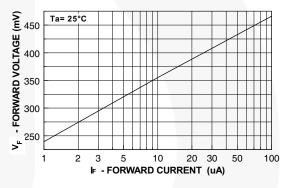


Figure 4. Forward Voltage vs. Forward Current V_{F} - 1.0 to 100 μA

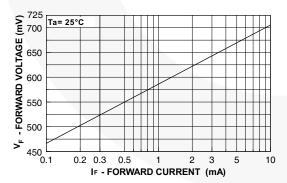


Figure 5. Forward Voltage vs. Forward Current V_F - 0.1 to 10 mA

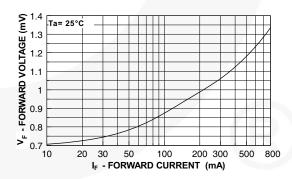


Figure 6. Forward Voltage vs. Forward Current V_F - 10 to 800 mA

Typical Performance Characteristics (Continued)

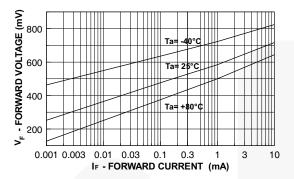


Figure 7. Forward Voltage vs. Ambient Temperature V_F - 1.0 μ A - 10 mA (- 40 to +80°C)

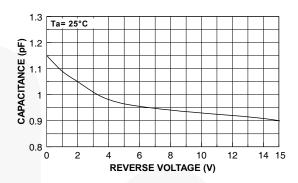


Figure 8. Capacitance vs. Reverse Voltage

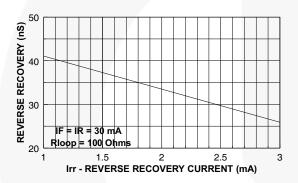


Figure 9. Reverse Recovery Time vs. Reverse Recovery Current (Irr)

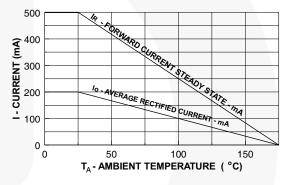


Figure 10. Average Rectified Current(I_O) and Forward Current (I_F) vs. Ambient Temperature(T_A)

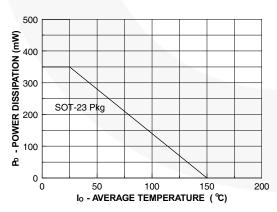
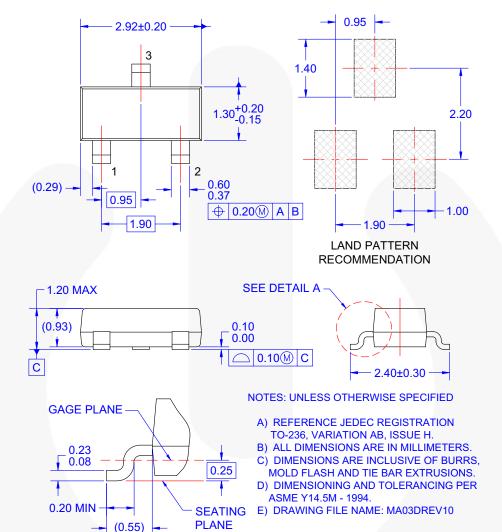


Figure 11. Power Derating Curve

Physical Dimensions



DETAIL A

Figure 12. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE





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